

Data sheet acquired from Harris Semiconductor SCHS205I

# CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

February 1998 - Revised February 2005

### Features

- Typical Propagation Delay: 6ns at V<sub>CC</sub> = 5V, C<sub>L</sub> = 15pF, T<sub>A</sub> =  $25^{\circ}$ C
- High-to-Low Voltage Level Converter for up to V<sub>I</sub> = 16V
- Fanout (Over Temperature Range)
  - Standard Outputs ..... 10 LSTTL Loads
- Bus Driver Outputs ..... 15 LSTTL Loads
- Wide Operating Temperature Range ...–55<sup>o</sup>C to 125<sup>o</sup>C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
  - 2V to 6V Operation
  - High Noise Immunity: N<sub>IL</sub> = 30%, N<sub>IH</sub> = 30% of V<sub>CC</sub> at V<sub>CC</sub> = 5V

### Pinout

CD54HC4049, CD54HC4050 (CERDIP) CD74HC4049, CD74HC4050 (PDIP, SOIC, SOP, TSSOP) TOP VIEW

4049	<u>4050</u>			<u>4050</u>	<u>4049</u>
v <sub>cc</sub>	V <sub>CC</sub> 1	Ū.	16	NC	NC
<u>1</u> Y	1Y 2		15	6Y	<u>6Y</u>
1 <b>A</b>	1A 🛛		14	6A	6A
<u>2</u> Y	2Y 4		13	NC	NC
2A	2A 5		12	5Y	<u>5</u> 7
<u>3</u> 7	3Y 6		11	5A	5A
3A	3A 7		10	4Y	$\overline{4Y}$
GND	GND 8		9	4A	4A

# High-Speed CMOS Logic Hex Buffers, Inverting and Non-Inverting

### Description

The 'HC4049 and 'HC4050 are fabricated with high-speed silicon gate technology. They have a modified input protection structure that enables these parts to be usedas logic level translators which convert high-level logic to a low-level logic while operating off the low-level logic supply. For example, 15-V input pulse levels can be down-converted to 0-V to 5-V logic levels. The modified input protection structure protects the input from negative electrostatic discharge. These parts also can be used as simple buffers or inverters without level translation. The 'HC4049 and 'HC4050 are enhanced versions of equivalent CMOS types.

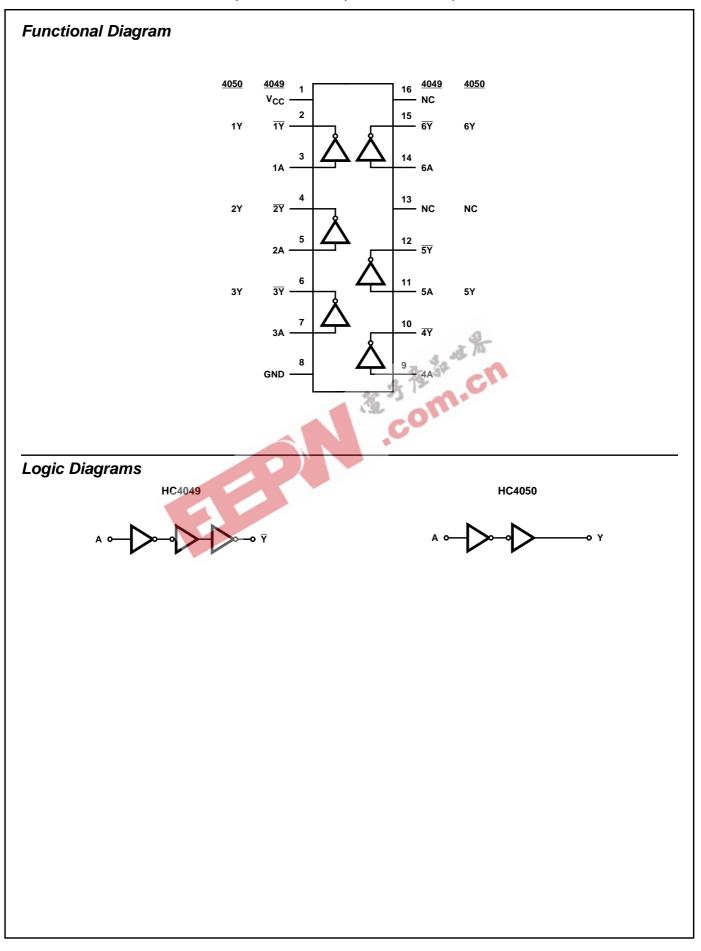
# **Ordering Information**

	, jis	
PART NUMBER	TEMP. RANGE (°C)	PACKAGE
CD54HC4049F3A	-55 to 125	16 Ld CERDIP
CD54HC4050F3A	-55 to 125	16 Ld CERDIP
CD74HC4049E	-55 to 125	16 Ld PDIP
CD74HC4049M	-55 to 125	16 Ld SOIC
CD74HCT4050MT	-55 to 125	16 Ld SOIC
CD74HC4049M96	-55 to 125	16 Ld SOIC
CD74HC4049NSR	-55 to 125	16 Ld SOP
CD74HC4049PW	-55 to 125	16 Ld TSSOP
CD74HC4049PWR	-55 to 125	16 Ld TSSOP
CD74HC4049PWT	-55 to 125	16 Ld TSSOP
CD74HC4050E	-55 to 125	16 Ld PDIP
CD74HC4050M	-55 to 125	16 Ld SOIC
CD74HC4050MT	-55 to 125	16 Ld SOIC
CD74HC4050M96	-55 to 125	16 Ld SOIC
CD74HC4050NSR	-55 to 125	16 Ld SOP
CD74HC4050PW	-55 to 125	16 Ld TSSOP
CD74HC4050PWR	-55 to 125	16 Ld TSSOP
CD74HC4050PWT	-55 to 125	16 Ld TSSOP

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper IC Handling Procedures.

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# CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

#### **Absolute Maximum Ratings**

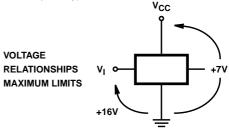
DC Supply Voltage, V <sub>CC</sub> 0.5V to 7V Input Voltage Range0.5V to 16V
DC Input Diode Current, I <sub>IK</sub>
For V <sub>I</sub> < -0.5V20mA
DC Output Diode Current, I <sub>OK</sub>
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V\pm 20$ mA
DC Output Source or Sink Current per Output Pin, IO
For $V_{O} > -0.5V$ or $V_{O} < V_{CC} + 0.5V$ ±25mA
DC V <sub>CC</sub> or Ground Current, I <sub>CC or</sub> I <sub>GND</sub> ±50mA

### **Operating Conditions**

Temperature Range (T <sub>A</sub> )–55 <sup>o</sup> C to 125 <sup>o</sup> C
Supply Voltage Range, V <sub>CC</sub>
HC Types
HCT Types
DC Input Voltage, VI0V to 15V
DC Output Voltage, V <sub>O</sub> 0V to V <sub>CC</sub>
Input Rise and Fall Time
2V
4.5V 500ns (Max)
6V

#### **Thermal Information**

Package Thermal Impedance, $\theta_{JA}$ (see Note 1):
E (PDIP) Package67 <sup>o</sup> C/W
M (SOIC) Package73 <sup>0</sup> C/W
NS (SOP) Package 64 <sup>o</sup> C/W
PW (TSSOP) Package 108°C/W
Maximum Junction Temperature (Hermetic Package or Die) 175 <sup>o</sup> C
Maximum Junction Temperature (Plastic Package)
Maximum Storage Temperature Range65°C to 150°C
Maximum Lead Temperature (Soldering 10s)
(SOIC - Lead Tips Only)



CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. m.c

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#### NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7

#### –55<sup>0</sup>C TO TEST 25°C –40°C TO 85°C CONDITIONS 125<sup>0</sup>C Vcc (V) PARAMETER SYMBOL V<sub>1</sub> (V) MIN TYP MAX MIN MAX MIN MAX UNITS Io (mA) HC TYPES High Level Input VIH 2 1.5 --1.5 -1.5 V -Voltage 3.15 4.5 3.15 3.15 V ----6 4.2 -4.2 4.2 V Low Level Input VIL 2 --0.5 -0.5 -0.5 V -\_ Voltage 4.5 1.35 1.35 1.35 V ----V 6 1.8 1.8 1.8 \_ \_ \_ \_ High Level Output -0.02 2 V Vон VIH or VIL 1.9 1.9 1.9 ----Voltage -0.02 4.5 4.4 4.4 4.4 V ----CMOS Loads -0.02 6 5.9 --5.9 -5.9 -V High Level Output -4 4.5 3.98 3.84 3.7 V -Voltage -5.2 6 5.48 5.34 -5.2 V ---TTL Loads Low Level Output VOL VIH or VIL 0.02 2 0.1 0.1 0.1 V ----Voltage 0.02 4.5 --0.1 -0.1 -0.1 V CMOS Loads 0.02 0.1 0.1 V 6 0.1 ----Low Level Output 0.4 4 4.5 \_ \_ 0.26 -0.33 \_ V Voltage 5.2 6 0.26 0.33 0.4 V ----TTL Loads Input Leakage 6 ±0.1 μA h V<sub>CC</sub> or ±1 ±1 GND Current 15 -6 -\_ ±0.5 ±5 ±5 --

#### **DC Electrical Specifications**

# CD54HC4049, CD74HC4049, CD54HC4050, CD74HC4050

			EST ITIONS	v <sub>cc</sub>	25°C		-	–40°C TO 85°C		–55 <sup>0</sup> C TO 125 <sup>0</sup> C			
PARAMETER	SYMBOL	V <sub>I</sub> (V)	I <sub>O</sub> (mA)	(V)	MI	N T	YP N	ЛАХ	MIN	MAX	MIN	MAX	UNITS
Quiescent Device Current	ICC	V <sub>CC</sub> or GND	0	6	-		-	2	-	20	-	40	μA
Switching Specifica	ations Ir	nput t <sub>r</sub> , t <sub>f</sub> =	6ns	_					-40°	с то		<sup>2</sup> С ТО	Ī
PARAMETER			TEST				25 <sup>0</sup> C		85 <sup>0</sup> C		125 <sup>0</sup> C		
		SYMBOL	CONDITION	s v <sub>cc</sub>	; (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
HC TYPES		•		-							•		
Propagation Delay,	t <sub>F</sub>	PLH, <sup>t</sup> PHL	$C_L = 50 pF$	2	2	-	-	85	-	105	-	130	ns
nA to nY HC4049 nA to nY HC4050				4.	5	-	-	17	-	21	-	26	ns
				6	;	-	-	14	-	18	-	22	ns
		ľ	C <sub>L</sub> = 15pF	5	;	-	6	-	-	-	-	-	ns
Transition Times (Figure 1)		rlh, t <sub>thl</sub>	$C_L = 50 pF$	2	2	-	-	75	-	95	-	110	ns
				4.	5	-	-	15	Ser.	19	-	22	ns
				6	;	-		13	-	16	-	19	ns
							100	100	-		1	1	+
Input Capacitance		CI	-	-		- 1		10	10 A 1	10	-	10	pF

NOTES:

(Notes 2, 3)

2. C<sub>PD</sub> is used to determine the dynamic power consumption, per gate.

3.  $P_D = V_{CC}^2 f_i (C_{PD} + C_L)$  where  $f_i = Input$  Frequency,  $C_L = Output$  Load Capacitance,  $V_{CC} = Supply$  Voltage.

# Test Circuit and Waveform

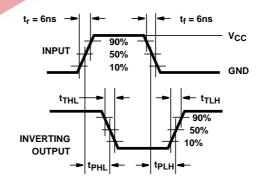


FIGURE 1. HC AND HCU TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC



# PACKAGE OPTION ADDENDUM

9-Oct-2007

## **PACKAGING INFORMATION**

5962-8681901EA     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       5962-868201EA     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD54HC4049F3A     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD74HC4049F3A     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD74HC4049EE4     ACTIVE     PDIP     N     16     25     PD-Free     CU NIPDAU     N / A for Pkg Type       CD74HC4049ME4     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no SUB)       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no SUB)       CD74HC4049M96G4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no SUB)       CD74HC4049M9644     ACTIVE     SOIC     D     16 <th>Orderable Device</th> <th>Status <sup>(1)</sup></th> <th>Package Type</th> <th>Package Drawing</th> <th>Pins</th> <th>Package Qty</th> <th>e Eco Plan<sup>(2)</sup></th> <th>Lead/Ball Finish</th> <th>MSL Peak Temp <sup>(3)</sup></th>	Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
CD54HC4049F3A     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD54HC4049E4     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD74HC4049E4     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049E44     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049ME44     ACTIVE     SOIC     D     16     2500     Green (RoHS & CD74HC4049M96E4     CU NIPDAU     Level-1-260C-UNLIM no SbB01       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CD 74HC4049M96G4     ACTIVE     SOIC     D     16     2600     Green (RoHS & CD 74HC4049M96G4     ACTIVE     SOIC     D     16     260     Green (RoHS & CD 74HC4049M64     Level-1-260C-UNLIM no SbB01       CD74HC4049M64     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no SbB01	5962-8681901EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD54HC4050F3A     ACTIVE     CDIP     J     16     1     TBD     A42 SNPB     N / A for Pkg Type       CD74HC4049E     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049E4     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049M     ACTIVE     SOIC     D     16     40     Green (RoHS & 0 Sb/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049M964     ACTIVE     SOIC     D     16     2500     Green (RoHS & 0 Sb/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049M9664     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049M964     ACTIVE     SOIC     D     16     260     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049MT64     ACTIVE     SOIC     D     16     260     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049MT64	5962-8682001EA	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD74HC4049E     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049E4     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC4049M     ACTIVE     SOIC     D     16     40     Green (RoHS & OSb/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049M96     ACTIVE     SOIC     D     16     2500     Green (RoHS & OSB/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & OSB/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049ME4     ACTIVE     SOIC     D     16     40     Green (RoHS & OSB/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049ME4     ACTIVE     SOIC     D     16     40     Green (RoHS & OSB/B)     CU NIPDAU     Level-1-260C-UNLIM no Sb/B)       CD74HC4049MG4     ACTIVE     SOIC     D     16     250     Green (RoHS & OSB/B)     CU NIPDAU	CD54HC4049F3A	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
CD74HC4049EE4     ACTIVE     PDIP     N     16     25     Pb-Free (RoHS)     CU NIPDAU     N / A for Pkg Type       CD74HC40499M     ACTIVE     SOIC     D     16     40     Green (RoHS & no Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049M966     ACTIVE     SOIC     D     16     2500     Green (RoHS & Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & No Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049M96G4     ACTIVE     SOIC     D     16     400     Green (RoHS & No Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049ME4     ACTIVE     SOIC     D     16     400     Green (RoHS & No Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & No Sb/Br)     CU NIPDAU     Level-1-260C-UNLIM no Sb/Br)       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS	CD54HC4050F3A	ACTIVE	CDIP	J	16	1	TBD	A42 SNPB	N / A for Pkg Type
(RoHS)     (RoHS)     (CD74HC4049M     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M96     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M6E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049ME4     ACTIVE     SOIC     D     16     400     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049ME4     ACTIVE     SOIC     D     16     240     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MT     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MT64     ACTIVE     SOIC     D     16	CD74HC4049E	ACTIVE	PDIP	Ν	16	25		CU NIPDAU	N / A for Pkg Type
no Sb/Br)     no Sb/Br)       CD74HC4049M96     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M96G4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M64     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MG4     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MT     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049NSR     ACTIVE     SOIC     D </td <td>CD74HC4049EE4</td> <td>ACTIVE</td> <td>PDIP</td> <td>Ν</td> <td>16</td> <td>25</td> <td></td> <td>CU NIPDAU</td> <td>N / A for Pkg Type</td>	CD74HC4049EE4	ACTIVE	PDIP	Ν	16	25		CU NIPDAU	N / A for Pkg Type
No Sb/Br)       CD74HC4049M96E4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049M96G4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049ME4     ACTIVE     SOIC     D     16     400     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049ME4     ACTIVE     SOIC     D     16     400     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MT4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049MT64     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049NSR     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM       CD74HC4049NSR     ACTIVE     SOIC     D     16	CD74HC4049M	ACTIVE	SOIC	D	16	40	<b>`</b>	CU NIPDAU	Level-1-260C-UNLIM
Inc Sb/Bi.     CD74HC4049M96G4     ACTIVE     SOIC     D     16     2500     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049ME4     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049MG4     ACTIVE     SOIC     D     16     40     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049MT     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049MTE4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049MTG4     ACTIVE     SOIC     D     16     250     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049NSR     ACTIVE     SOIC     D     16     2000     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049NSR     ACTIVE     SO     NS     16     2000     Green (RoHS & CU NIPDAU     Level-1-260C-UNLIM no Sb/Bi)       CD74HC4049NSR64     ACTIVE	CD74HC4049M96	ACTIVE	SOIC	D	16	2500		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049ME4ACTIVESOICD1640Green (RoHS & cU NIPDAULevel-1-260C-UNLIMCD74HC4049MG4ACTIVESOICD1640Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTACTIVESOICD16250Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTE4ACTIVESOICD16250Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MT64ACTIVESOICD16250Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MT64ACTIVESOICD16250Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRACTIVESONS162000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRE4ACTIVESONS162000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRG4ACTIVESONS162000Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR4ACTIVETSSOPPW1690Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR4ACTIVETSSOPPW1690Green (RoHS & cU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR4ACTIVETSSOPPW	CD74HC4049M96E4	ACTIVE	SOIC	D	16	2500		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049MG4ACTIVESOICD1640Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTE4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTG4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTG4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRACTIVESOICD162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRE4ACTIVESONS162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRG4ACTIVESONS162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWACTIVETSSOPPW1690Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR64ACTIVE <td>CD74HC4049M96G4</td> <td>ACTIVE</td> <td>SOIC</td> <td>D</td> <td>16</td> <td>2500</td> <td></td> <td>CU NIPDAU</td> <td>Level-1-260C-UNLIM</td>	CD74HC4049M96G4	ACTIVE	SOIC	D	16	2500		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049MTACTIVESOLCD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTE4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTG4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049MTG4ACTIVESOICD16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRACTIVESONS162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRE4ACTIVESONS162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049NSRG4ACTIVESONS162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWR64AC	CD74HC4049ME4	ACTIVE	SOIC	D	16	<b>4</b> 0		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049MTE4ACTIVESOICD16250Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049MTG4ACTIVESOICD16250Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049MTG4ACTIVESOICD162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049NSRACTIVESONS162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049NSRE4ACTIVESONS162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049NSRG4ACTIVESONS162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWACTIVETSSOPPW1690Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRe4ACTIVETSSOPPW1690Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRe4ACTIVETSSOPPW162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRe4ACTIVETSSOPPW162000Green (ROHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRe4ACTIVE <td>CD74HC4049MG4</td> <td>ACTIVE</td> <td>SOIC</td> <td>D</td> <td>16</td> <td>40</td> <td></td> <td>CU NIPDAU</td> <td>Level-1-260C-UNLIM</td>	CD74HC4049MG4	ACTIVE	SOIC	D	16	40		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049MTG4ACTIVESOICD16250Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049NSRACTIVESONS162000Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049NSRE4ACTIVESONS162000Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049NSRE4ACTIVESONS162000Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049NSRG4ACTIVESONS162000Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049PWRe4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAU no Sb/Br)Level-1-260C-UNLIMCD74HC4049PWRe4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAU 	CD74HC4049MT	ACTIVE	SOIC	P	16	250	•	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049NSRACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049NSRE4ACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049NSR64ACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR64ACTIVETSSOPPW162000Green (RO	CD74HC4049MTE4	ACTIVE	SOIC	D	16	250	<b>`</b>	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049NSRE4ACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIMCD74HC4049NSRG4ACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIMCD74HC4049PWACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWR64ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWTACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWTACTIVETSSOP <td>CD74HC4049MTG4</td> <td>ACTIVE</td> <td>SOIC</td> <td>D</td> <td>16</td> <td>250</td> <td><b>`</b></td> <td>CU NIPDAU</td> <td>Level-1-260C-UNLIM</td>	CD74HC4049MTG4	ACTIVE	SOIC	D	16	250	<b>`</b>	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049NSRG4ACTIVESONS162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRF4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	CD74HC4049NSR	ACTIVE	SO	NS	16	2000	•	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & cu NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWRACTIVETSSOPPW162000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & cu NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & cu NIPDAULevel-1-260C-UNLIM Level-1-260C-UNLIM	CD74HC4049NSRE4	ACTIVE	SO	NS	16	2000		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWE4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRF4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	CD74HC4049NSRG4	ACTIVE	SO	NS	16	2000		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWG4ACTIVETSSOPPW1690Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)CD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM no Sb/Br)	CD74HC4049PW	ACTIVE	TSSOP	PW	16	90	•	CU NIPDAU	Level-1-260C-UNLIM
no Šb/Br)     CD74HC4049PWR   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & no Sb/Br)   CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWRE4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWRG4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWRG4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWT   ACTIVE   TSSOP   PW   16   250   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)	CD74HC4049PWE4	ACTIVE	TSSOP	PW	16	90		CU NIPDAU	Level-1-260C-UNLIM
no Šb/Br)     CD74HC4049PWRE4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & no Sb/Br)   CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWRG4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWRG4   ACTIVE   TSSOP   PW   16   250   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWT   ACTIVE   TSSOP   PW   16   250   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM	CD74HC4049PWG4	ACTIVE	TSSOP	PW	16	90		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWRE4ACTIVETSSOPPW162000Green (RoHS & no Sb/Br)CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWRG4ACTIVETSSOPPW162000Green (RoHS & cU NIPDAULevel-1-260C-UNLIMCD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIMCD74HC4049PWTACTIVETSSOPPW16250Green (RoHS & CU NIPDAULevel-1-260C-UNLIM	CD74HC4049PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWRG4   ACTIVE   TSSOP   PW   16   2000   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM no Sb/Br)     CD74HC4049PWT   ACTIVE   TSSOP   PW   16   250   Green (RoHS & CU NIPDAU   Level-1-260C-UNLIM	CD74HC4049PWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWT ACTIVE TSSOP PW 16 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM	CD74HC4049PWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
	CD74HC4049PWT	ACTIVE	TSSOP	PW	16	250		CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWTE4 ACTIVE TSSOP PW 16 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM no Sb/Br)	CD74HC4049PWTE4	ACTIVE	TSSOP	PW	16	250	Green (RoHS &	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4049PWTG4 ACTIVE TSSOP PW 16 250 Green (RoHS & CU NIPDAU Level-1-260C-UNLIM	CD74HC4049PWTG4	ACTIVE	TSSOP	PW	16	250	,	CU NIPDAU	Level-1-260C-UNLIM

# PACKAGE OPTION ADDENDUM



9-Oct-2007

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3</sup>
						no Sb/Br)		
CD74HC4050E	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD74HC4050EE4	ACTIVE	PDIP	Ν	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
CD74HC4050M	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4050M96	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050M96E4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050M96G4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050ME4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050MG4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050MT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050MTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050MTG4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050NSR	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4050NSRE4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4050NSRG4	ACTIVE	SO	NS	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4050PW	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
CD74HC4050PWE4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWG4	ACTIVE	TSSOP	PW	16	90	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWR	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWRE4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWRG4	ACTIVE	TSSOP	PW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWT	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWTE4	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN
CD74HC4050PWTG4	ACTIVE	TSSOP	PW	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIN

<sup>(1)</sup> The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in



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#### a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available. **OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. **TBD**: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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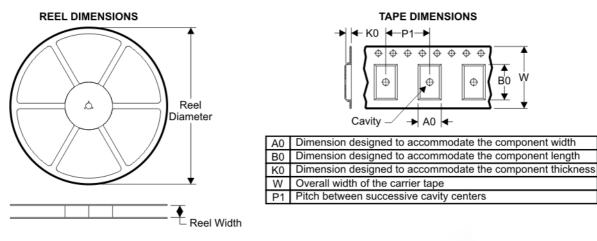
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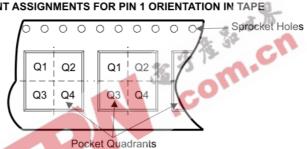
# **PACKAGE MATERIALS INFORMATION**

4-Oct-2007

### TAPE AND REEL BOX INFORMATION



QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPES

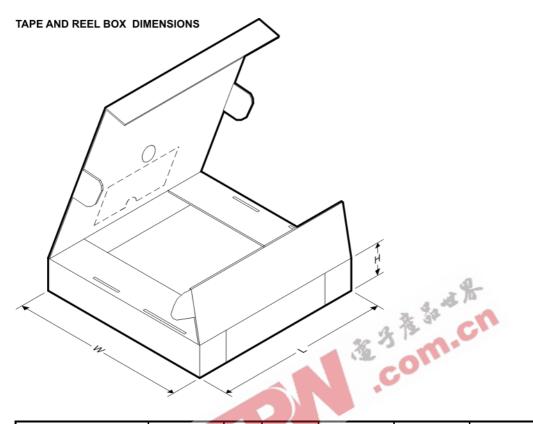


Device	Package	Pins		Reel Diameter (mm)	Reel Width (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
CD74HC4049M96	D	16	SITE 27	330	16	6.5	10.3	2.1	8	16	Q1
CD74HC4049NSR	NS	16	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
CD74HC4049PWR	PW	16	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1
CD74HC4050M96	D	16	SITE 27	330	16	6.5	10.3	2.1	8	16	Q1
CD74HC4050NSR	NS	16	SITE 41	330	16	8.2	10.5	2.5	12	16	Q1
CD74HC4050PWR	PW	16	SITE 41	330	12	7.0	5.6	1.6	8	12	Q1



# PACKAGE MATERIALS INFORMATION

4-Oct-2007



Device	Package	Pins	Site	Length (mm)	Width (mm)	Height (mm)
CD74HC4049M96	D	16	SITE 27	342.9	336.6	28.58
CD74HC4049NSR	NS	16	SITE 41	346.0	346.0	33.0
CD74HC4049PWR	PW	16	SITE 41	346.0	346.0	29.0
CD74HC4050M96	D	16	SITE 27	342.9	336.6	28.58
CD74HC4050NSR	NS	16	SITE 41	346.0	346.0	33.0
CD74HC4050PWR	PW	16	SITE 41	346.0	346.0	29.0

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